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Amendments to the Specification

Please amend the paragraph commencing at line 5, page 7 as follows:

– Next, in step 4 a <u>sacrificial</u> layer 22 of CRPVD TiN about 0.10 μm thick is deposited at 400° C. In step 5, a layer 24 of PECVD Si₂N₄ about 0.40 μm thick is deposited at 400° C. In step 6, a <u>sacrificial</u> layer 26 of CRPVD TiN about 0.20 μm thick is deposited at 400° C. —

Please amend the paragraph commencing at line 21, page 7 as follows:

-- In <u>step</u> 9, shown in Figure 4, a layer of CRPVD TiN 30 about 0.10 μm thick is deposited at 400°C. --